Chip Box - Assembled



RoHS Compliant



Description

The product is a Chip Box with conductive foam. This chip box provide an ESD safe and small electronic devices. Designed from corstat conductive corrugated fibre-board. Assembled with high density pin stick grade conductive foam.

Specifications

ESD Storage Type : Box

External Dimension (W×H) : 100mm×15mm

Part Number Table

Description	Part Number
Chip Box with conductive foam	026-0466

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